

Electronic Acknowledgement Receipt

EFS ID:	1450063
Application Number:	10517670
International Application Number:	
Confirmation Number:	1922
Title of Invention:	Heat curable adhesive composition, article, semiconductor apparatus and method
First Named Inventor/Applicant Name:	Kohichiro Kawate
Customer Number:	32692
Filer:	John A. Burtis/Kathy Sandvig
Filer Authorized By:	John A. Burtis
Attorney Docket Number:	58028US006
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Application Type:	U.S. National Stage under 35 USC 371

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed	58028US006_SIDS.pdf	85818	no	3

Warnings:

Information:

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.